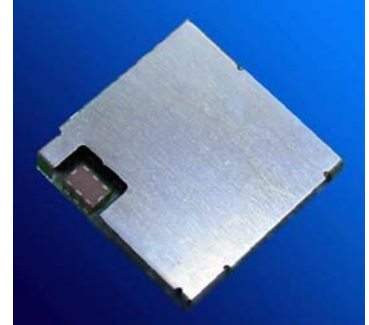


## DFCM-MGC31

### WLAN/ Bluetooth Combo Module

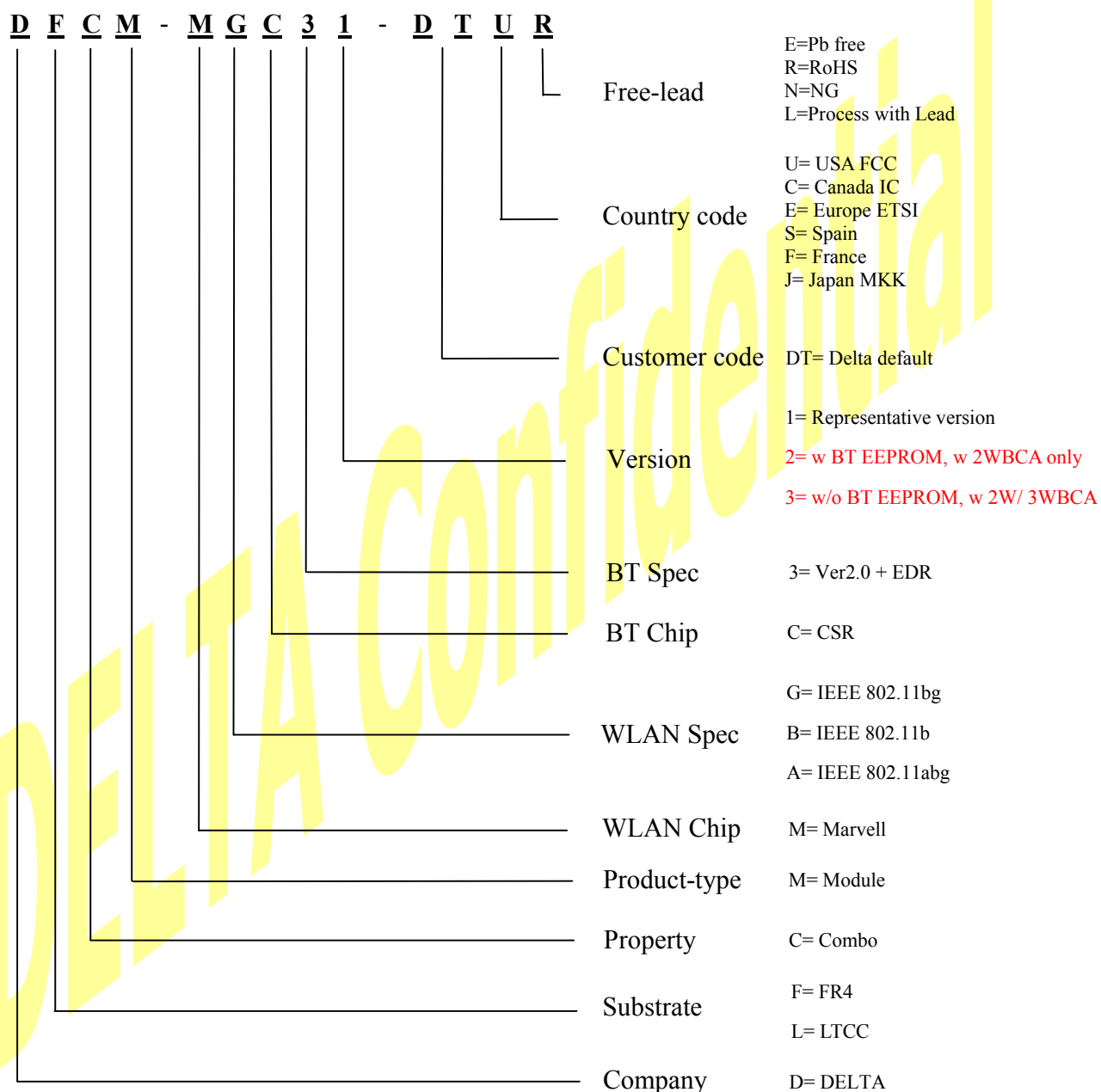
*An IEEE 802.11g&b WLAN plus v2.0 + EDR Bluetooth Module for various applications.*



#### 1. Features:

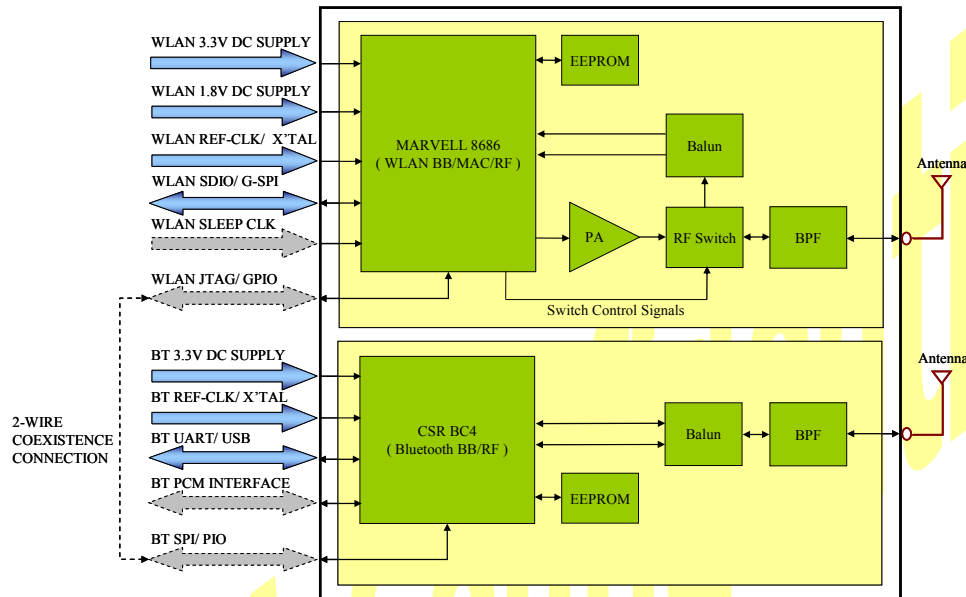
- Applications for cellular handsets and consumer electronic devices that require low power consumption
- Compared with DFWM-MHG21
  - The same chip ( MARVELL 8686 ), the reusable software
  - The same radio performance
  - Lower power dissipation ( **22% current saved when Tx** )
  - A 1.8V DC supply and a ref-clock source required
- Compared with DFBM-CS32x series
  - The same chip ( CSR BC4 ROM ), the reusable software
  - Great radio performance
  - A ref-clock source required
- Compact module size the same as DFWM-MHG21
- High isolation between integrated WLAN and BT circuits
- Two Crystal Mode/ Single XOSC Mode verified
- Single Antenna Mode/ Dual Antenna Mode supported
- 2WBCA (2-Wire Bluetooth Coexist Arbitration)/ 3WBCA supported ( Please refer to the Section 2, Model No. Definition )
- Fine coexistence performance on embedded platforms

## 2.Combo Module Model No. Definition

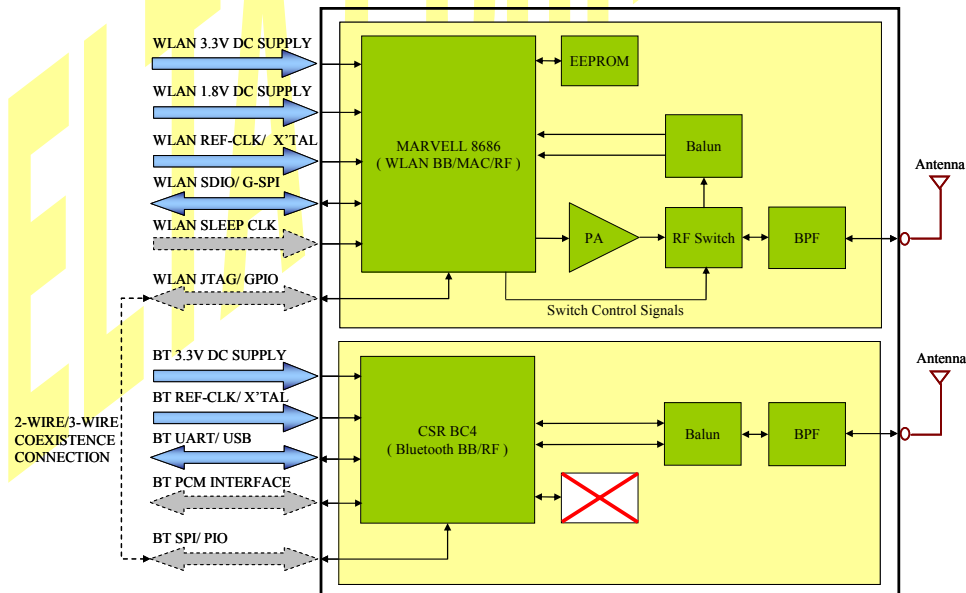


### 3. Block Diagram:

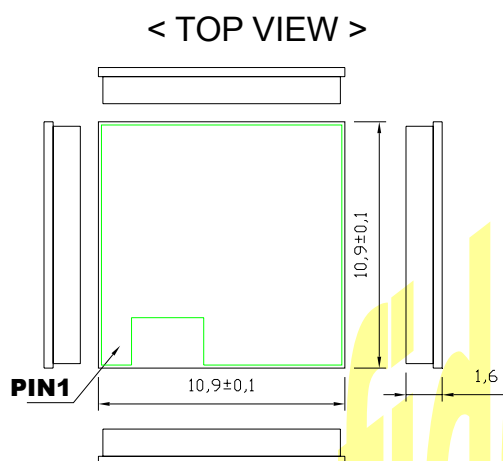
#### 3.1 DFCM-MGC32



#### 3.2 DFCM-MGC33



## 4. Dimensions (mm):



## 5. Module Standard Brief

### 5.1 Whole Module

| Item                          | Specification              |
|-------------------------------|----------------------------|
| Package Type                  | 101 pins LGA SMT Component |
| Dimension                     | 10.9x10.9x1.6mm            |
| Coexistence Type              | 2-Wire Mode/ 3-Wire Mode*  |
| Storage Temperature           | -40°C ~ +110°C             |
| Storage Humidity              | 5~95%                      |
| Ambient Operating Temperature | -25°C ~ +80°C              |
| Operating Humidity            | 10~90%                     |
| Baking Condition              | 125°C/24hrs or 45°C/192hrs |

**NOTE:** \* DFCM-MGC32: with a BT EEPROM inside, supports 2-Wire Mode only.  
 DFCM-MGC33: without a BT EEPROM inside, supports both of 2-Wire Mode and 3-Wire Mode, Needs Host porting to boot Bluetooth

( Please also refer to the Section 2. Model No. Definition on page 2 )

## 5.2 WLAN Section

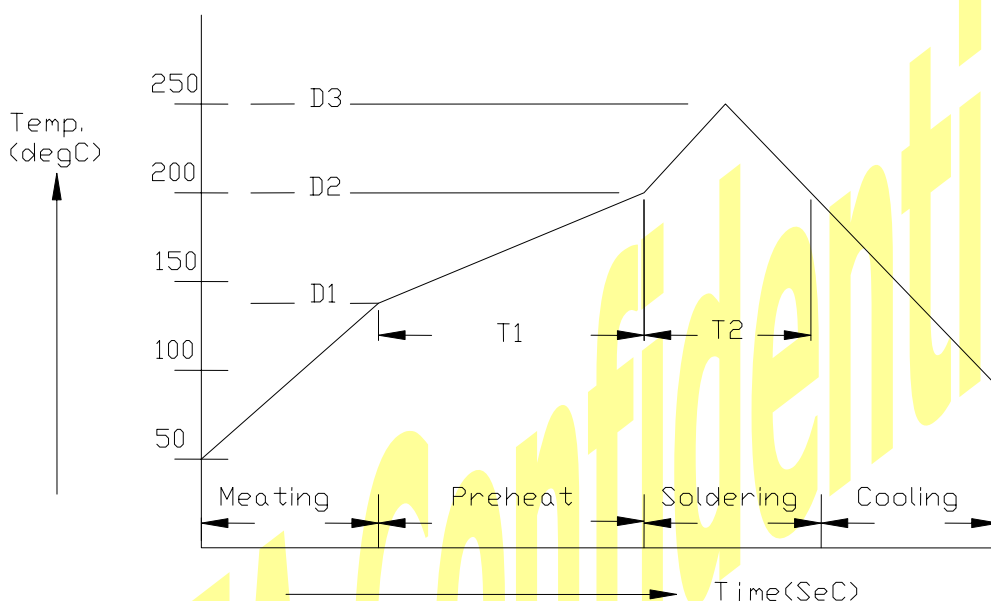
| Item                  | Specification  |
|-----------------------|--|
| Chip Solution         | MARVELL 8686   |
| Product Standard      | Compliant with IEEE 802.11, 802.11b and 802.11g  |
| Operation Voltage     | 3.0~3.3V and 1.7~1.9V  |
| Host Interface        | SDIO and G-SPI   |
| Host Requirement      | External 1.8V power supply and reference clock source  |
| OS and Driver Support | WinCE/ WinMobile 5.0, Linux2.6, WinXP and WinVista   |
| Security Support      | 64/128-bit WEP with hardware TKIP processing, WPA and WPA2 with AES-CCMP hardware implementation |

## 5.3 Bluetooth Section

| Item                  | Specification                                      |
|-----------------------|--|
| Chip Solution         | CSR BC4 ROM  |
| Product Standard      | Compliant with Bluetooth v2.0 + EDR                |
| Operation Voltage     | 2.2~3.6V   |
| Host Interface        | UART and USB                                       |
| Host Requirement      | External reference clock source                    |
| OS and Driver Support | WinCE/ WinMobile 5.0, Linux2.6, WinXP and WinVista |

## 6.Recommended Reflow Profile:

### 6.1 Reflow Soldering Profile



**NOTE:** 1. Reflow soldering is recommended two times maximum.  
2. If your soldering conditions are different from our recommendation, please feel free to consult with us.

| No. | Item       | Temperature (°C)  | Time (sec)   |
|-----|------------|-------------------|--------------|
| 1   | Pre-heat   | D1: 140 ~ D2: 200 | T1: 60 ~ 120 |
| 2   | Soldering  | D2: $\geq 200$    | T2: 80 max   |
| 3   | Peak-Temp. | D3: 250 °C max    |              |

### 6.2 Soldering Iron Condition

- (1) Temperature: 350 °C max
- (2) Duration: 4 sec max (1 part)
- (3) Capacity: 30W max

## 7.WLAN Software Support:

### 7.1 Standard Software Platforms

| Item. | Host Operating System   | SDIO Interface | G-SPI Interface |
|-------|-------------------------|----------------|-----------------|
| 1     | WinCE/ WinMobile (v5.0) | Available      | Available       |
| 2     | Linux (Kernel v2.6)     | Available      | Available       |
| 3     | WinXP                   | Available      | Not yet         |
| 4     | WinVista                | Available      | Not yet         |

### 7.2 G-SPI Software Features

| Item. | Features  | Item | Features (Continued)                  |
|-------|---|------|---------------------------------------|
| 1     | 802.11b/g Infrastructure scan, associate and ping               | 15   | 802.11d                               |
| 2     | 802.11b/g Ad-Hoc mode scan, associate and ping                  | 16   | WMM (Linux only)                      |
| 3     | IEEE Power Save   | 17   | Background Scan in Deep Sleep Mode    |
| 4     | Ad-Hoc Security (WEP only)                                      | 18   | Bluetooth Co-existence                |
| 5     | Infra WEP   | 19   | Host Sleep (Infrastructure Mode only) |
| 6     | Infra WPA/802.1x  | 20   | Ad-Hoc Power Save                     |
| 7     | Infra WPA2  | --   | --                                    |
| 8     | Reserved  | --   | --                                    |
| 9     | TPC   | --   | --                                    |
| 10    | Deep Sleep  | --   | --                                    |
| 11    | CCX v1 (driver and firmware support only; no supplicant )       | --   | --                                    |
| 12    | Subscribe Event API   | --   | --                                    |
| 13    | Local Listen Interval Field Added to Power Save (Enter) Command | --   | --                                    |
| 14    | UAPSD   | --   | --                                    |

### 7.3 SDIO Software Features

| Item. | Features  | Item | Features (Continued)  |
|-------|---|------|---|
| 1     | 802.11b/g Infrastructure scan, associate and ping               | 16   | WMM (Linux only)  |
| 2     | 802.11b/g Ad-Hoc mode scan, associate and ping                  | 17   | Background Scan in Deep Sleep Mode                            |
| 3     | IEEE Power Save   | 18   | Bluetooth Co-existence  |
| 4     | Ad-Hoc Security (WEP only)                                      | 19   | Host Sleep (Infrastructure Mode only)                         |
| 5     | Infra WEP   | 20   | Ad-Hoc Power Save   |
| 6     | Infra WPA/802.1x  | 21   | Background Scan in Infra Mode                                 |
| 7     | Infra WPA2  | 22   | Background Scan wit Infra IEEE PS                             |
| 8     | SDIO interface support (SDIO only)                              | 23   | Inactivity Timeout  |
| 9     | TPC   | 24   | CCX v2 ASD (driver and firmware support only; no supplicant ) |
| 10    | Deep Sleep  | 25   | CCX v3 ASD (driver and firmware support only; no supplicant ) |
| 11    | CCX v1 (driver and firmware support only; no supplicant )       | 26   | Null packet screen before Host Wakeup                         |
| 12    | Subscribe Event API   | 27   | Crypto API to host (AES, RC4)                                 |
| 13    | Local Listen Interval Field Added to Power Save (Enter) Command | 28   | UAPSD for legacy APs  |
| 14    | UAPSD   | 29   | CCX v4 ASD (driver and firmware support only; no supplicant ) |
| 15    | 802.11d   | --   | --  |

**NOTE:** Please contact DELTA to get more information about the software support for different OS platforms.



## 10. Revision History:

| Date       | Description  | Maker    |
|------------|--|----------|
| 2007/04/20 | Initial release  | Jim.Chen |
| 2007/05/25 | Update the module's photo, features, model number definition | Jim.Chen |

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